onsemi

MOSFET – N-Channel, POWERTRENCH[®]

80 V, 100 A, 4.2 m Ω

FDD86367-F085

Features

- Typical $R_{DS(on)} = 3.3 \text{ m}\Omega$ at $V_{GS} = 10 \text{ V}$, $I_D = 80 \text{ A}$
- Typical $Q_{g(tot)} = 68 \text{ nC}$ at $V_{GS} = 10 \text{ V}$, $I_D = 80 \text{ A}$
- UIS Capability
- AEC-Q101 Qualified and PPAP Capable
- This Device is Pb–Free, Halogen Free/BFR Free and is RoHS Compliant

Applications

- Automotive Engine Control
- PowerTrain Management
- Solenoid and Motor Drivers
- Integrated Starter/Alternator
- Primary Switch for 12 V Systems

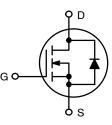
WOSPET WAANNOW RATINGS (I J = 25 C uniess ounerwise holed)							
Symbol	Parameter	Ratings	Unit				
VDSS	Drain-to-Source Voltage	80	V				
Vgs	Gate-to-Source Voltage	±20	V				
Ι _D	Drain Current – Continuous (V _{GS} = 10) (Note 1) $T_C = 25^{\circ}C$	100	A				
	Pulsed Drain Current $T_C = 25^{\circ}C$	See Figure 4					
E _{AS}	Single Pulse Avalanche Energy (Note 2)	82	mJ				
PD	Power Dissipation	227	W				
	Derate Above 25°C	1.52	W/°C				
T _J , T _{STG}	Operating and Storage Temperature	-55 to +175	°C				
$R_{\theta JC}$	Thermal Resistance, Junction to Case	0.66	°C/W				
R_{\thetaJA}	Maximum Thermal Resistance, Junction to Ambient (Note 3)	52	°C/W				

MOSFET MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

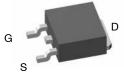
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Current is limited by bondwire configuration.

- 2. Starting $T_J = 25^{\circ}$ C, $L = 40 \,\mu$ H, $I_{AS} = 64$ A, $V_{DD} = 80$ V during inductor charging and $V_{DD} = 0$ V during time in avalanche.
- 3. R_{0JA} is the sum of the junction-to-case and case-to-ambient thermal resistance, where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{0JC} is guaranteed by design, while R_{0JA} is determined by the board design. The maximum rating presented here is based on mounting on a 1 in² pad of 2oz copper.



N-Channel



DPAK3 (TO-252 3 LD) CASE 369AS

MARKING DIAGRAM



= onsemi Logo

\$Y

&Z &3

&K

- = Assembly Plant Code
- = 3-Digit Date Code
- = 2-Digits Lot Run Traceability Code

ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

FDD86367-F085

PACKAGE MARKING AND ORDERING INFORMATION

Device	Device Marking	Package	Reel Size	Tape Width	Shipping [†]
FDD86367-F085	FDD86367	DPAK3 (TO-252 3 LD) (Pb-Free)	13"	16 mm	2500 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise noted)

Symbol	Parameter	Condition		Min	Тур	Max	Unit
OFF CHA	RACTERISTICS	•					
B _{VDSS}	Drain-to-Source Breakdown Voltage	I_D = 250 μ A, V_{GS} =	0 V	80	-	-	V
I _{DSS}	Drain-to-Source Leakage Current		$T_J = 25^{\circ}C$	-	-	1	mA
			T _J = 175°C (Note 4)	-	-	1	mA
I _{GSS}	Gate-to-Source Leakage Current	V_{GS} = ±20 V		-	-	±100	nA
ON CHAR	ACTERISTICS						
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}$, $I_D = 250 \ \mu A$		2	3	4	V
R _{DS(on)}	Drain to Source On Resistance	I _D = 80 A, V _{GS} = 10 V	$T_J = 25^{\circ}C$	-	3.3	4.2	mΩ
			T _J = 175°C (Note 4)	-	6.6	8.4	mΩ
DYNAMIC	CHARACTERISTICS						
C _{iss}	Input Capacitance	V_{DS} = 40 V, V_{GS} = 0 V, f = 1 MHz		-	4840	-	pF
C _{oss}	Output Capacitance			-	814	-	pF
C _{rss}	Reverse Transfer Capacitance			-	31	-	pF
Rg	Gate Resistance	V _{GS} = 0.5 V, f = 1 MHz		-	2.3	-	Ω
Q _{g(ToT)}	Total Gate Charge	V _{GS} = 0 to 10 V	$V_{DD} = 40 V,$	-	68	88	nC
Q _{g(th)}	Threshold Gate Charge	V_{GS} = 0 to 2 V	I _D = 80 A	-	8.8	-	nC
Q _{gs}	Gate-to-Source Gate Charge	V _{DD} = 40 V, I _D = 80 A		-	22	-	nC
Q _{gd}	Gate-to-Drain "Miller" Charge			_	14	_	nC

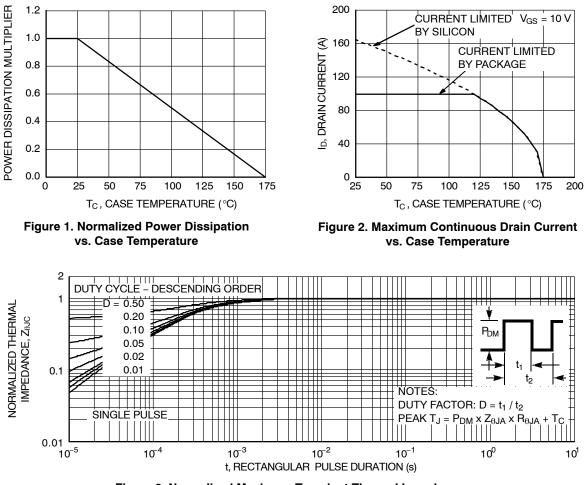
t _{on}	Turn-On Time	$V_{DD} = 40 \text{ V}, \text{ I}_{D} = 80 \text{ A}, \text{ V}_{GS} = 10 \text{ V}, \\ \text{R}_{\text{GEN}} = 6 \Omega$	-	-	104	ns
t _{d(on)}	Turn-On Delay		-	20	-	ns
tr	Rise Time		-	49	-	ns
t _{d(off)}	Turn-Off Delay		-	36	-	ns
t _f	Fall Time		-	16	-	ns
t _{off}	Turn-Off Time		-	-	80	ns

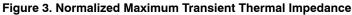
DRAIN-SOURCE DIODE CHARACTERISTICS

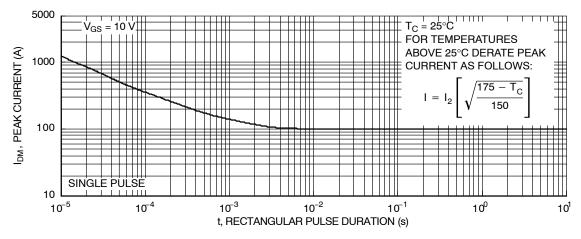
V_{SD}	Source-to-Drain Diode Voltage	I _{SD} = 80 A, V _{GS} = 0 V	-	-	1.3	V
		$I_{SD} = 40 \text{ A}, V_{GS} = 0 \text{ V}$	-	-	1.2	V
t _{rr}	Reverse-Recovery Time	V_{DD} = 64 V, I_F = 80 A, dI_{SD}/dt = 100 A/µs	-	68	102	ns
Q _{rr}	Reverse-Recovery Charge		-	66	106	nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. The maximum value is specified by design at $T_J = 175^{\circ}$ C. Product is not tested to this condition in production.

TYPICAL CHARACTERISTICS









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TYPICAL CHARACTERISTICS (continued)

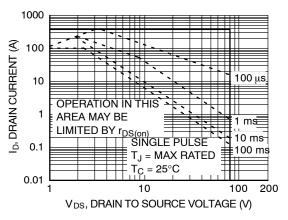
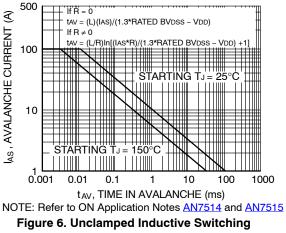
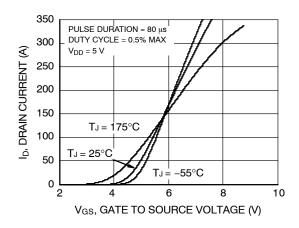


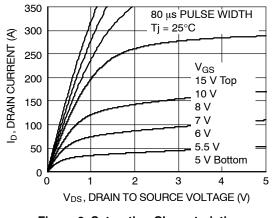
Figure 5. Forward Bias Safe Operating Area



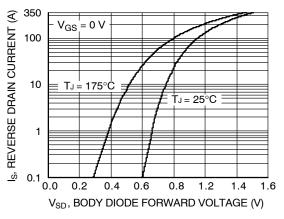
Capability



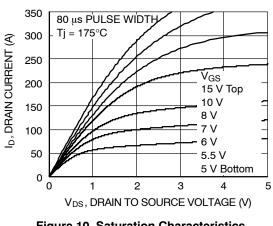








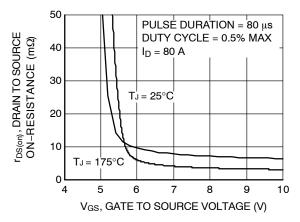


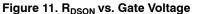




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TYPICAL CHARACTERISTICS (continued)





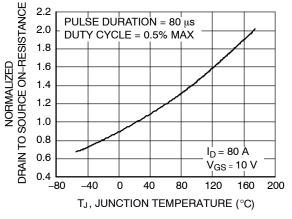


Figure 12. Normalized RDSON vs. Junction Temperature

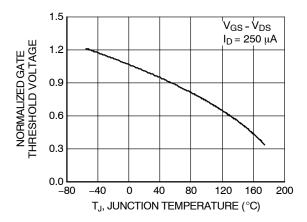


Figure 13. Normalized Gate Threshold Voltage vs. Temperature

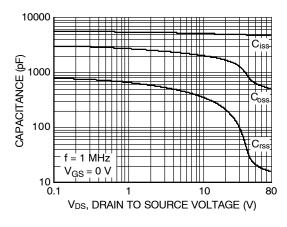


Figure 15. Capacitance vs. Drain to Source Voltage

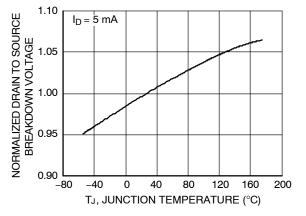


Figure 14. Normalized Drain to Source Breakdown Voltage vs. Junction Temperature

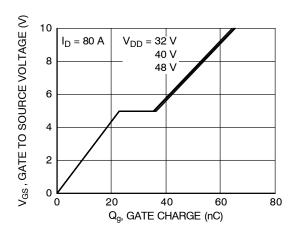
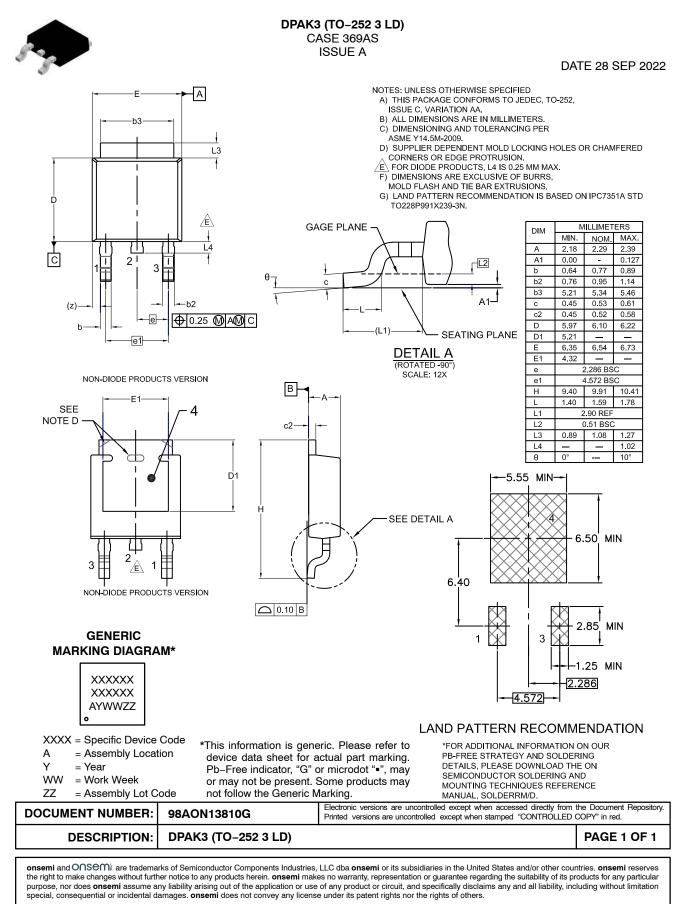


Figure 16. Gate Charge vs. Gate to Source Voltage

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MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS

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